# Darlington Transistor NPN Silicon

### Features

- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage	V <sub>CEO</sub>	40	Vdc
Collector – Base Voltage	V <sub>CBO</sub>	40	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	12	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	500	mAdc

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR–5 Board, (Note 1) T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	225 1.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) $T_A = 25^{\circ}C$ Derate above 25°C	P <sub>D</sub>	300 2.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1.  $FR-5 = 1.0 \times 0.75 \times 0.062$  in.

2. Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.

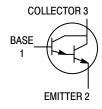


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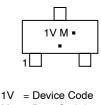
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SOT-23 (TO-236) CASE 318 STYLE 6



### MARKING DIAGRAM





= Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or overbar may vary depending upon manufacturing location.

### **ORDERING INFORMATION**

	Device	Package	Shipping <sup>†</sup>				
M	MBT6427LT1G	SOT-23 (Pb-Free)	3,000 Tape & Reel				
SN	MBT6427LT1G	SOT-23 (Pb-Free)	3,000 Tape & Reel				

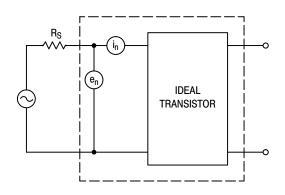
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector – Emitter Breakdown Voltage $(I_C = 10 \text{ mAdc}, V_{BE} = 0)$	V <sub>(BR)CEO</sub>	40	-	Vdc
Collector – Base Breakdown Voltage $(I_C = 100 \ \mu Adc, I_E = 0)$	V <sub>(BR)CBO</sub>	40	-	Vdc
Emitter – Base Breakdown Voltage $(I_C = 10 \ \mu Adc, I_C = 0)$	V <sub>(BR)EBO</sub>	12	-	Vdc
Collector Cutoff Current ( $V_{CE} = 25 \text{ Vdc}, I_B = 0$ )	ICES	-	1.0	μAdc
Collector Cutoff Current ( $V_{CB} = 30$ Vdc, $I_E = 0$ )			50	nAdc
Emitter Cutoff Current ( $V_{EB} = 10 \text{ Vdc}, I_C = 0$ )	I <sub>EBO</sub>	_	50	nAdc
ON CHARACTERISTICS				
	h <sub>FE</sub>	10,000 20,000 14,000	100,000 200,000 140,000	_
Collector – Emitter Saturation Voltage ( $I_C = 50 \text{ mAdc}, I_B = 0.5 \text{ mAdc}$ ) ( $I_C = 500 \text{ mAdc}, I_B = 0.5 \text{ mAdc}$ )	V <sub>CE(sat)</sub> <sup>(3)</sup>		1.2 1.5	Vdc
Base – Emitter Saturation Voltage (I <sub>C</sub> = 500 mAdc, I <sub>B</sub> = 0.5 mAdc)	V <sub>BE(sat)</sub>	-	2.0	Vdc
Base – Emitter On Voltage (I <sub>C</sub> = 50 mAdc, V <sub>CE</sub> = 5.0 Vdc)	V <sub>BE(on)</sub>	_	1.75	Vdc
SMALL-SIGNAL CHARACTERISTICS	I			
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>obo</sub>	_	7.0	pF
Input Capacitance	C <sub>ibo</sub>			pF

#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

odi  $(V_{EB} = 0.5 \text{ Vdc}, I_C = 0, f = 1.0 \text{ MHz})$ 15 \_  $\begin{array}{l} CurrentGain-High \ Frequency \\ (I_C=10\ mAdc,\ V_{CE}=5.0\ Vdc,\ f=100\ MHz) \end{array}$ |h<sub>fe</sub>| Vdc 1.3 \_ NF Noise Figure dB (I<sub>C</sub> = 1.0 mAdc, V<sub>CE</sub> = 5.0 Vdc, R<sub>S</sub> = 100 k $\Omega$ , f = 1.0 kHz) 10 \_

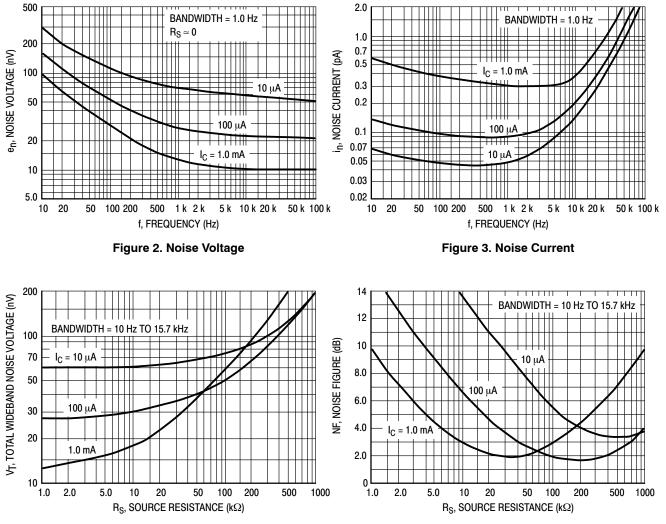
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle = 2.0%.





**NOISE CHARACTERISTICS** 

 $(V_{CE} = 5.0 \text{ Vdc}, \text{ T}_{A} = 25^{\circ}\text{C})$ 



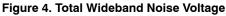
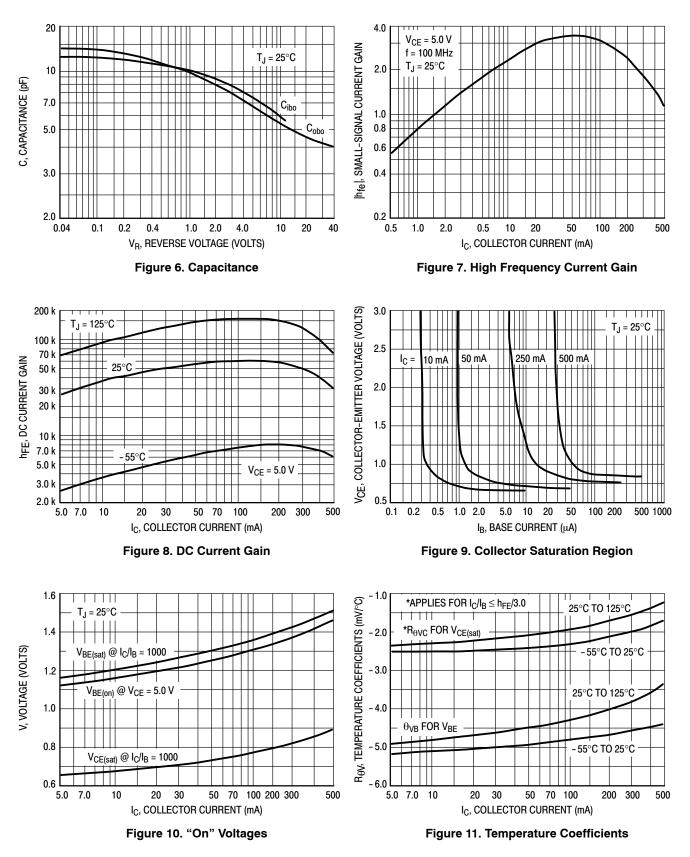


Figure 5. Wideband Noise Figure

### SMALL-SIGNAL CHARACTERISTICS



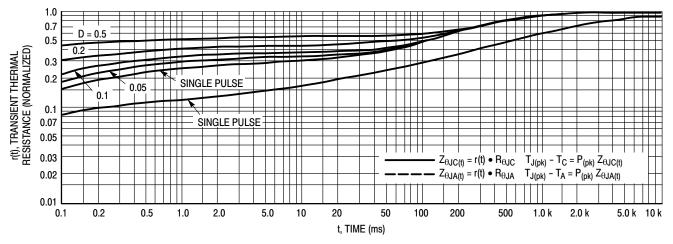
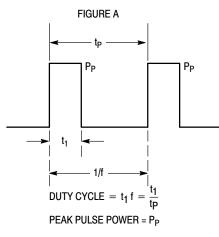


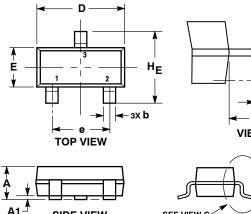
Figure 12. Thermal Response



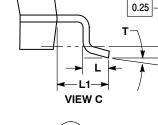
Design Note: Use of Transient Thermal Resistance Data

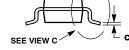
#### PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AR** 



SIDE VIEW





END VIEW

NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
- MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
- THE BASE MATERIAL.

4.	DIMENSIONS D'AND E DO NOT INCLUDE MOLD FLASH,
	PROTRUSIONS, OR GATE BURRS.

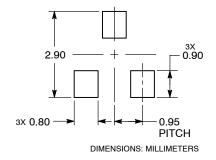
	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.89	1.00	1.11	0.035	0.039	0.044	
A1	0.01	0.06	0.10	0.000	0.002	0.004	
b	0.37	0.44	0.50	0.015	0.017	0.020	
С	0.08	0.14	0.20	0.003	0.006	0.008	
D	2.80	2.90	3.04	0.110	0.114	0.120	
Е	1.20	1.30	1.40	0.047	0.051	0.055	
е	1.78	1.90	2.04	0.070	0.075	0.080	
L	0.30	0.43	0.55	0.012	0.017	0.022	
L1	0.35	0.54	0.69	0.014	0.021	0.027	
ΗE	2.10	2.40	2.64	0.083	0.094	0.104	
Т	0°		10 °	0 °		10 °	

STYLE 6:

PIN 1. BASE 2.

EMITTER 3 COLLECTOR

RECOMMENDED SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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